

74AHC3GU04

Inverter

Rev. 01 — 5 March 2004

Product data sheet

1. General description

The 74AHC3GU04 is a high-speed Si-gate CMOS device. This device provides the inverting single stage function.

2. Features

- Symmetrical output impedance
- High noise immunity
- ESD protection:
 - ◆ HBM EIA/JESD22-A114-A exceeds 2000 V
 - ◆ MM EIA/JESD22-A115-A exceeds 200 V
 - ◆ CDM EIA/JESD22-C101 exceeds 1000 V.
- Low power dissipation
- Balanced propagation delays
- SOT505-2 and SOT765-1 package
- Output capability ± 8 mA drive
- Specified from -40 °C to $+85$ °C and from -40 °C to $+125$ °C.

3. Quick reference data

Table 1: Quick reference data

$GND = 0$ V; $T_{amb} = 25$ °C; $t_r = t_f \leq 3.0$ ns.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------------------|-------------------------------|----------------------------------|--------------|-----|-----|------|
| t_{PHL} , t_{PLH} | propagation delay nA to nY | $V_{CC} = 5$ V; $C_L = 15$ pF | - | 2.5 | 5.5 | ns |
| C_I | input capacitance | | - | 3.0 | 10 | pF |
| C_{PD} | power dissipation capacitance | | [1] - [2] | 4 | - | pF |

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts;

N = total load switching outputs;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

[2] The condition is $V_i = GND$ to V_{CC} .

PHILIPS

4. Ordering information

Table 2: Ordering information

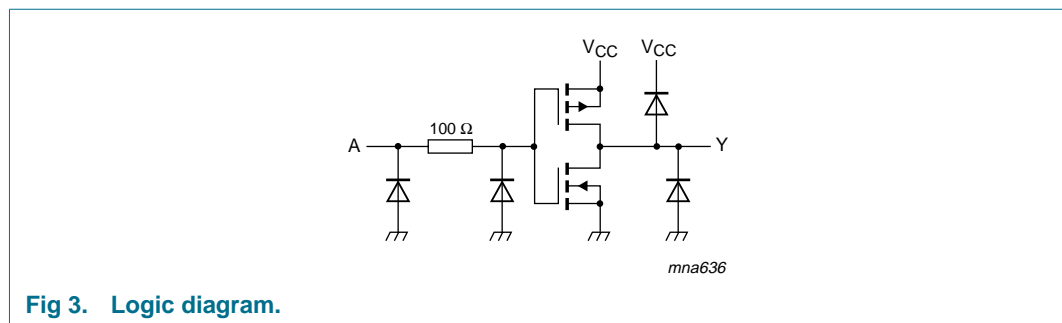
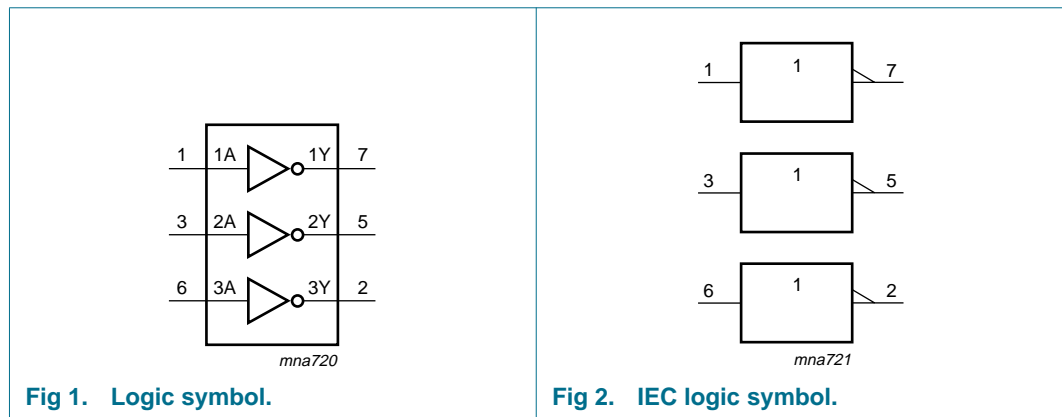
| Type number | Package | | | |
|--------------|-------------------|--------|---|----------|
| | Temperature range | Name | Description | Version |
| 74AHC3GU04DP | -40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm | SOT505-2 |
| 74AHC3GU04DC | -40 °C to +125 °C | VSSOP8 | plastic shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |

5. Marking

Table 3: Marking

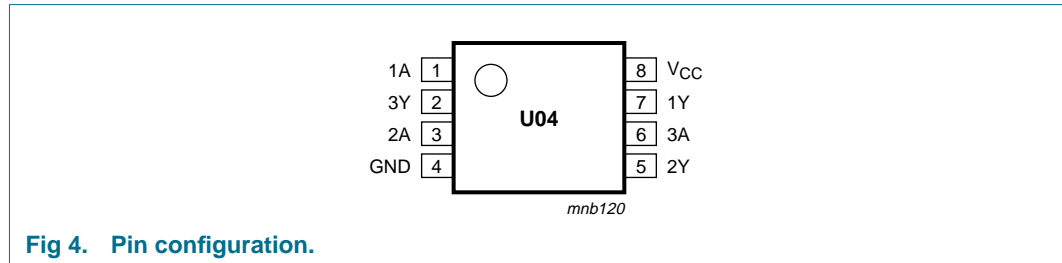
| Type number | Marking code |
|--------------|--------------|
| 74AHC3GU04DP | AU04 |
| 74AHC3GU04DC | AU4 |

6. Functional diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

Table 4: Pin description

| Pin | Symbol | Description |
|-----|-----------------|----------------|
| 1 | 1A | data input |
| 2 | 3Y | data output |
| 3 | 2A | data input |
| 4 | GND | ground (0 V) |
| 5 | 2Y | data output |
| 6 | 3A | data input |
| 7 | 1Y | data output |
| 8 | V _{CC} | supply voltage |

8. Functional description

8.1 Function table

Table 5: Function table ^[1]

| Input nA | Output nY |
|----------|-----------|
| L | H |
| H | L |

[1] H = HIGH voltage level;
L = LOW voltage level.

9. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-------------------|-------------------------------|--|------|----------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| V_I | supply voltage | | -0.5 | +7.0 | V |
| I_{IK} | input diode current | $V_I < -0.5$ V | - | -20 | mA |
| I_{OK} | output diode current | $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V | [1] | ± 20 | mA |
| I_O | output source or sink current | $V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V | - | ± 25 | mA |
| I_{CC}, I_{GND} | V_{CC} or GND current | | - | ± 75 | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | power dissipation | $T_{amb} = -40$ °C to +125 °C | - | 250 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

10. Recommended operating conditions

Table 7: Recommended operating operations

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------|-------------------------------|---|-----|-----|----------|------|
| V_{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | V |
| V_I | input voltage | | 0 | - | 5.5 | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | operating ambient temperature | see Section 11 and Section 12 | -40 | +25 | +125 | °C |
| t_r, t_f | input rise and fall times | $V_{CC} = 3.3$ V \pm 0.3 V | - | - | 100 | ns/V |
| | | $V_{CC} = 5$ V \pm 0.5 V | - | - | 20 | ns/V |

11. Static characteristics

Table 8: Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---|---|------|-----|------|------|
| T_{amb} = 25 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.7 | - | - | V |
| | | V _{CC} = 3.0 V | 2.4 | - | - | V |
| | | V _{CC} = 5.5 V | 4.4 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.3 | V |
| | | V _{CC} = 3.0 V | - | - | 0.6 | V |
| | | V _{CC} = 5.5 V | - | - | 1.1 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | V _{CC} = 2.0 V; I _O = -50 μA | 1.9 | 2.0 | - | V |
| | | V _{CC} = 3.0 V; I _O = -50 μA | 2.9 | 3.0 | - | V |
| | | V _{CC} = 4.5 V; I _O = -50 μA | 4.4 | 4.5 | - | V |
| | | V _{CC} = 3.0 V; I _O = -4.0 mA | 2.58 | - | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | V _{CC} = 2.0 V; I _O = 50 μA | - | 0 | 0.1 | V |
| | | V _{CC} = 3.0 V; I _O = 50 μA | - | 0 | 0.1 | V |
| | | V _{CC} = 4.5 V; I _O = 50 μA | - | 0 | 0.1 | V |
| | | V _{CC} = 3.0 V; I _O = 4.0 mA | - | - | 0.36 | V |
| I _{LI} | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | 0.1 | μA |
| | | | | | | |
| I _{CC} | quiescent supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 1.0 | μA |
| C _I | input capacitance | | - | 3.0 | 10 | pF |
| T_{amb} = -40 °C to 85 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.7 | - | - | V |
| | | V _{CC} = 3.0 V | 2.4 | - | - | V |
| | | V _{CC} = 5.5 V | 4.4 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.3 | V |
| | | V _{CC} = 3.0 V | - | - | 0.6 | V |
| | | V _{CC} = 5.5 V | - | - | 1.1 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -50 μA; V _{CC} = 2.0 V | 1.9 | - | - | V |
| | | I _O = -50 μA; V _{CC} = 3.0 V | 2.9 | - | - | V |
| | | I _O = -50 μA; V _{CC} = 4.5 V | 4.4 | - | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.48 | - | - | V |
| | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.8 | - | - | V | |

Table 8: Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---------------------------|---|------|-----|------|------|
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 50 μA; V _{CC} = 2.0 V | - | - | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 3.0 V | - | - | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.44 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.44 | V |
| I _{LI} | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | 1.0 | μA |
| I _{CC} | quiescent supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 10 | μA |
| C _I | input capacitance | | - | - | 10 | pF |
| T_{amb} = -40 °C to +125 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.7 | - | - | V |
| | | V _{CC} = 3.0 V | 2.4 | - | - | V |
| | | V _{CC} = 5.5 V | 4.4 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.3 | V |
| | | V _{CC} = 3.0 V | - | - | 0.6 | V |
| | | V _{CC} = 5.5 V | - | - | 1.1 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -50 μA; V _{CC} = 2.0 V | 1.9 | - | - | V |
| | | I _O = -50 μA; V _{CC} = 3.0 V | 2.9 | - | - | V |
| | | I _O = -50 μA; V _{CC} = 4.5 V | 4.4 | - | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.40 | - | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.70 | - | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 50 μA; V _{CC} = 2.0 V | - | - | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 3.0 V | - | - | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.55 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.55 | V |
| I _{LI} | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | 2.0 | μA |
| I _{CC} | quiescent supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 40 | μA |
| C _I | input capacitance | | - | - | 10 | pF |

12. Dynamic characteristics

Table 9: Dynamic characteristics

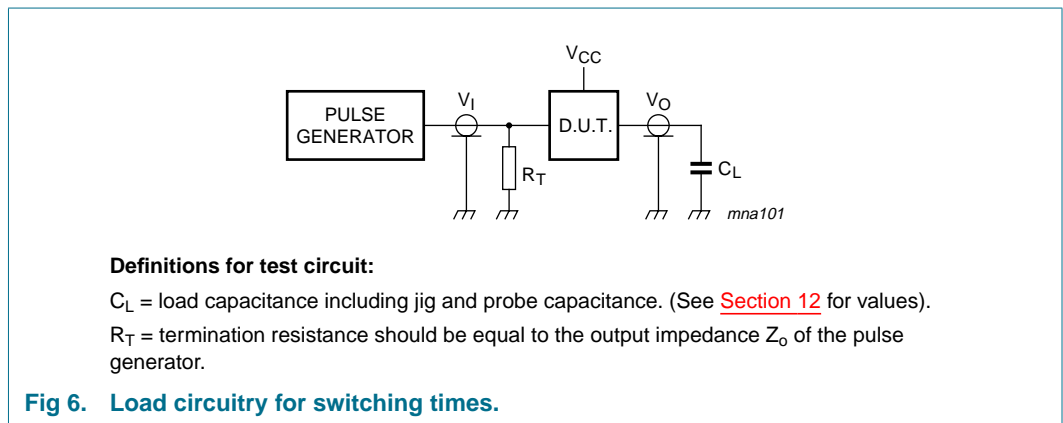
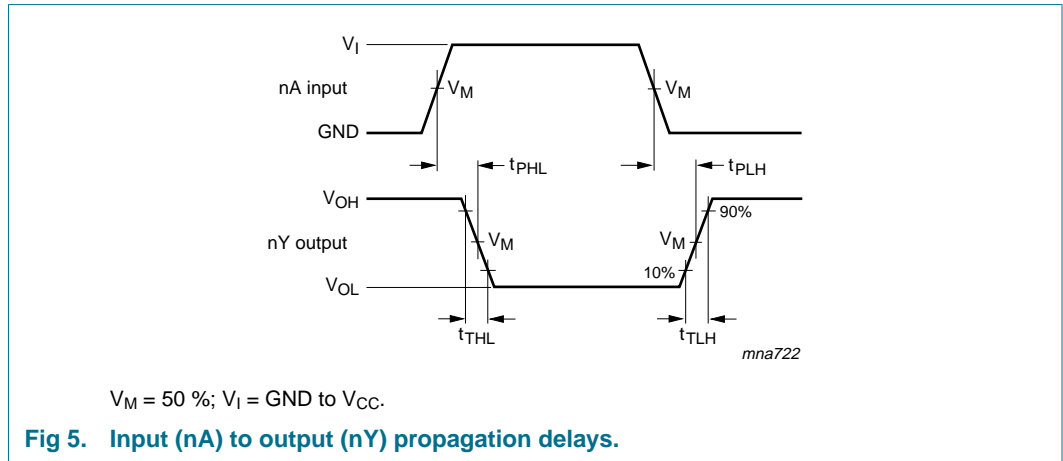
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $t_r = t_f \leq 3.0$ ns. See [Figure 6](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|----------------------------|---|-------|-----|------|------|
| $T_{amb} = 25\text{ °C}$ | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | see Figure 5 | | | | |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}; C_L = 15\text{ pF}$ | [1] - | 3.0 | 7.1 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}; C_L = 50\text{ pF}$ | [1] - | 4.3 | 10.6 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}; C_L = 15\text{ pF}$ | [2] - | 2.5 | 5.5 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}; C_L = 50\text{ pF}$ | [2] - | 3.5 | 7.0 | ns |
| $T_{amb} = -40\text{ °C to }85\text{ °C}$ | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | see Figure 5 | | | | |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}; C_L = 15\text{ pF}$ | 1.0 | - | 8.5 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}; C_L = 50\text{ pF}$ | 1.0 | - | 12.0 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}; C_L = 15\text{ pF}$ | 1.0 | - | 6.0 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}; C_L = 50\text{ pF}$ | 1.0 | - | 8.0 | ns |
| $T_{amb} = -40\text{ °C to }125\text{ °C}$ | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | see Figure 5 | | | | |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}; C_L = 15\text{ pF}$ | 1.0 | - | 10.0 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}; C_L = 50\text{ pF}$ | 1.0 | - | 13.5 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}; C_L = 15\text{ pF}$ | 1.0 | - | 7.0 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}; C_L = 50\text{ pF}$ | 1.0 | - | 9.0 | ns |

[1] Typical values are measured at $V_{CC} = 3.3\text{ V}$.

[2] Typical values are measured at $V_{CC} = 5.0\text{ V}$.

13. AC waveforms



13.1 Typical transfer characteristics

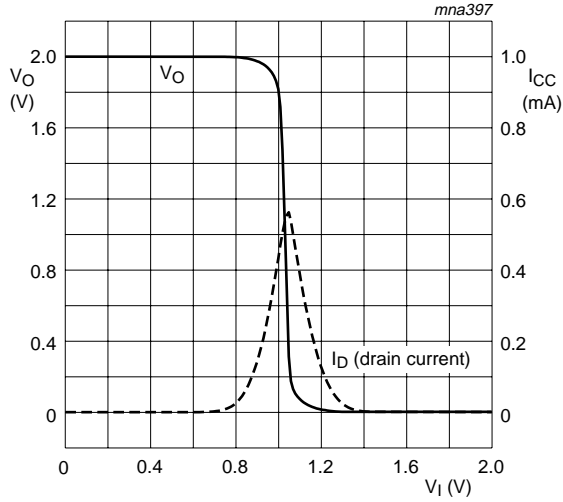


Fig 7. $V_{CC} = 2.0$ V; $I_O = 0$ A.

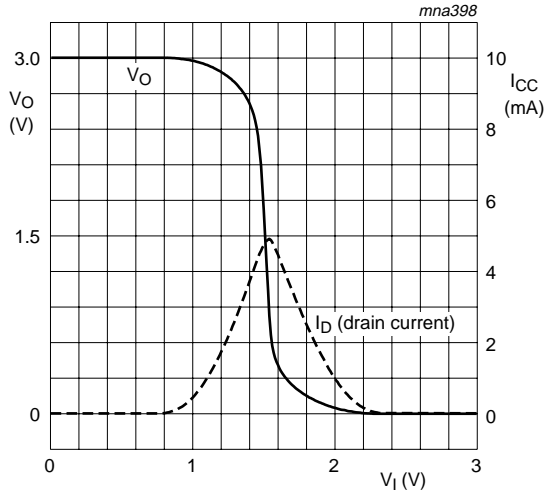


Fig 8. $V_{CC} = 3.0$ V; $I_O = 0$ A.

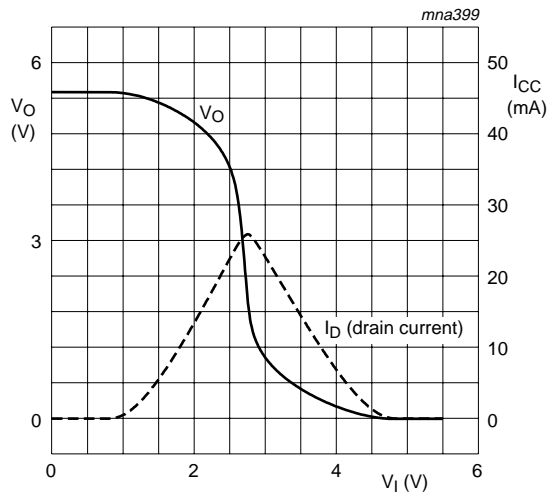
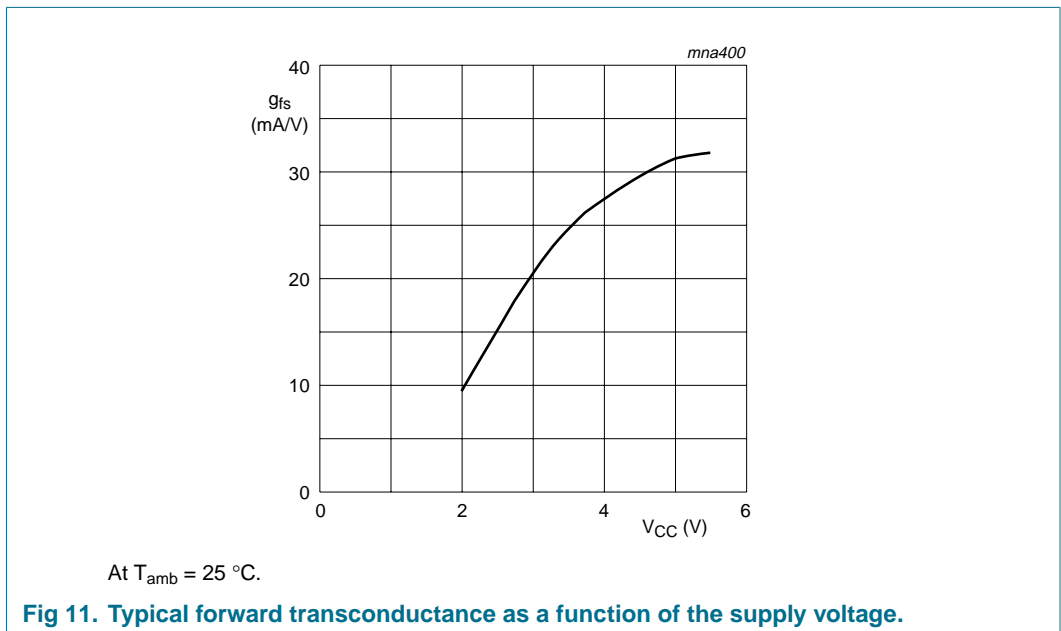
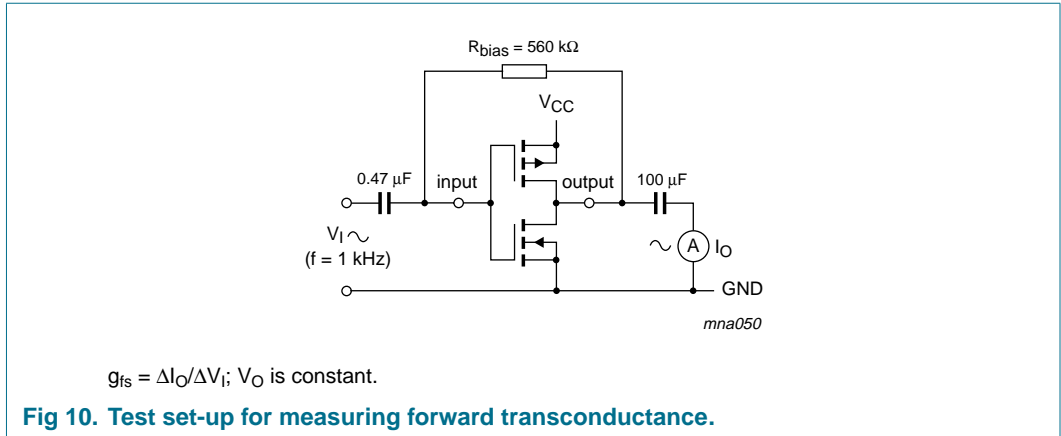


Fig 9. $V_{CC} = 5.5$ V; $I_O = 0$ A.

13.2 Forward transconductance



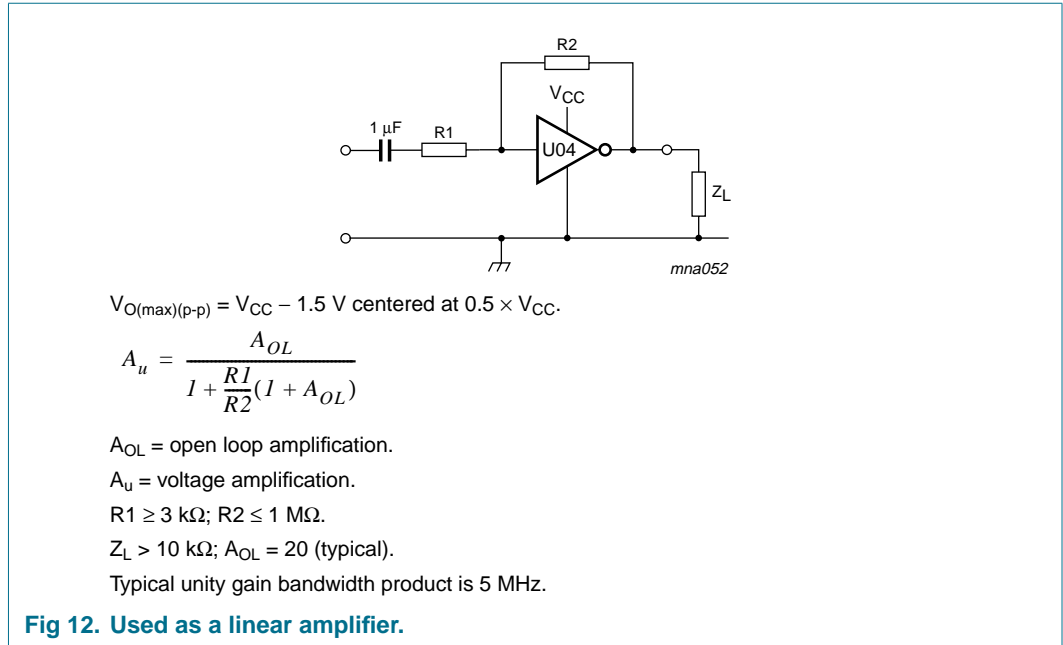
14. Application information

Some applications are:

- Linear amplifier see [Figure 12](#)
- In crystal oscillator design see [Figure 13](#).

Remark: All values given are typical unless otherwise specified.

14.1 Linear amplifier



14.2 Crystal oscillator

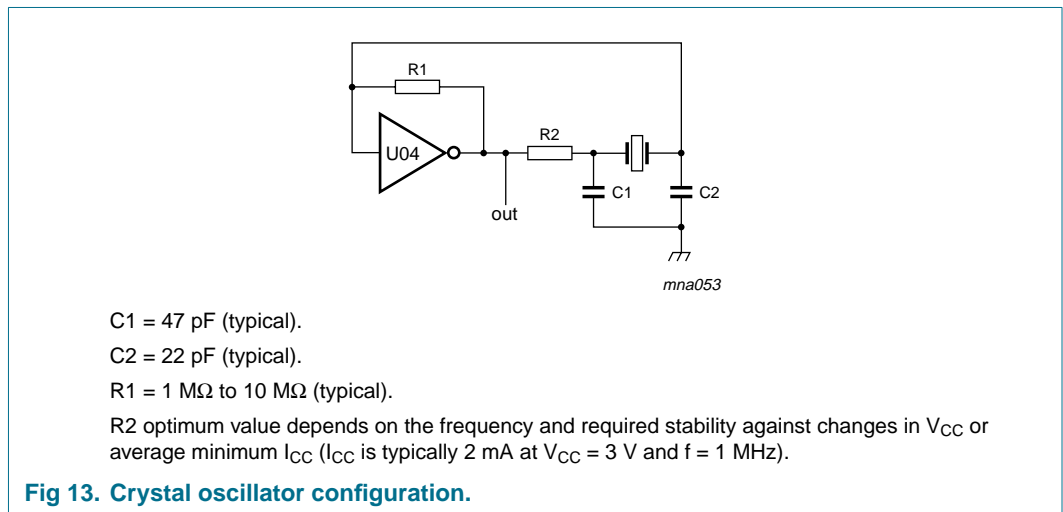


Table 10: External components for resonator (f < 1 MHz)

| Frequency (kHz) | R1 (MΩ) | R2 (kΩ) | C1 (pF) | C2 (pF) |
|-----------------|---------|---------|---------|---------|
| 10 to 15.9 | 22 | 220 | 56 | 20 |
| 16 to 24.9 | 22 | 220 | 56 | 10 |
| 25 to 54.9 | 22 | 100 | 56 | 10 |
| 55 to 129.9 | 22 | 100 | 47 | 5 |
| 130 to 199.9 | 22 | 47 | 47 | 5 |
| 200 to 349.9 | 22 | 47 | 47 | 5 |
| 350 to 600 | 22 | 47 | 47 | 5 |

Remark: All values given are typical and must be used as initial set-up.

Table 11: Optimum value for R2

| Frequency (kHz) | R2 (k Ω) | Optimum for |
|-----------------|------------------|--|
| 3 | 2.0 | minimum required I _{CC} |
| | 8.0 | minimum influence due to change in V _{CC} |
| 6 | 1.0 | minimum required I _{CC} |
| | 4.7 | minimum influence due to change in V _{CC} |
| 10 | 0.5 | minimum required I _{CC} |
| | 2.0 | minimum influence due to change in V _{CC} |
| 14 | 0.5 | minimum required I _{CC} |
| | 1.0 | minimum influence due to change in V _{CC} |
| >14 | - | replace R2 by C3 with a typical value of 35 pF |

15. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

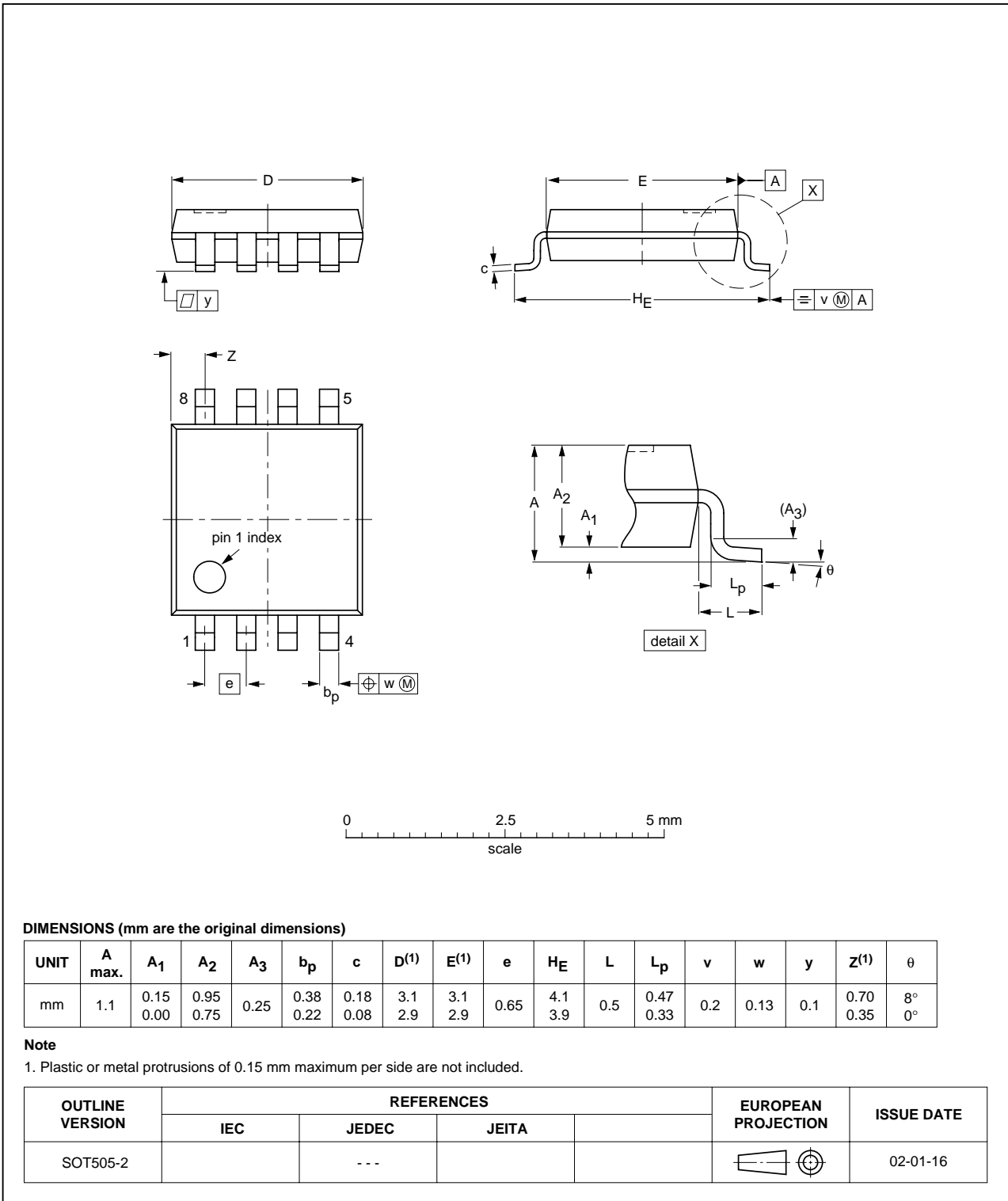


Fig 14. Package outline TSSOP8.

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

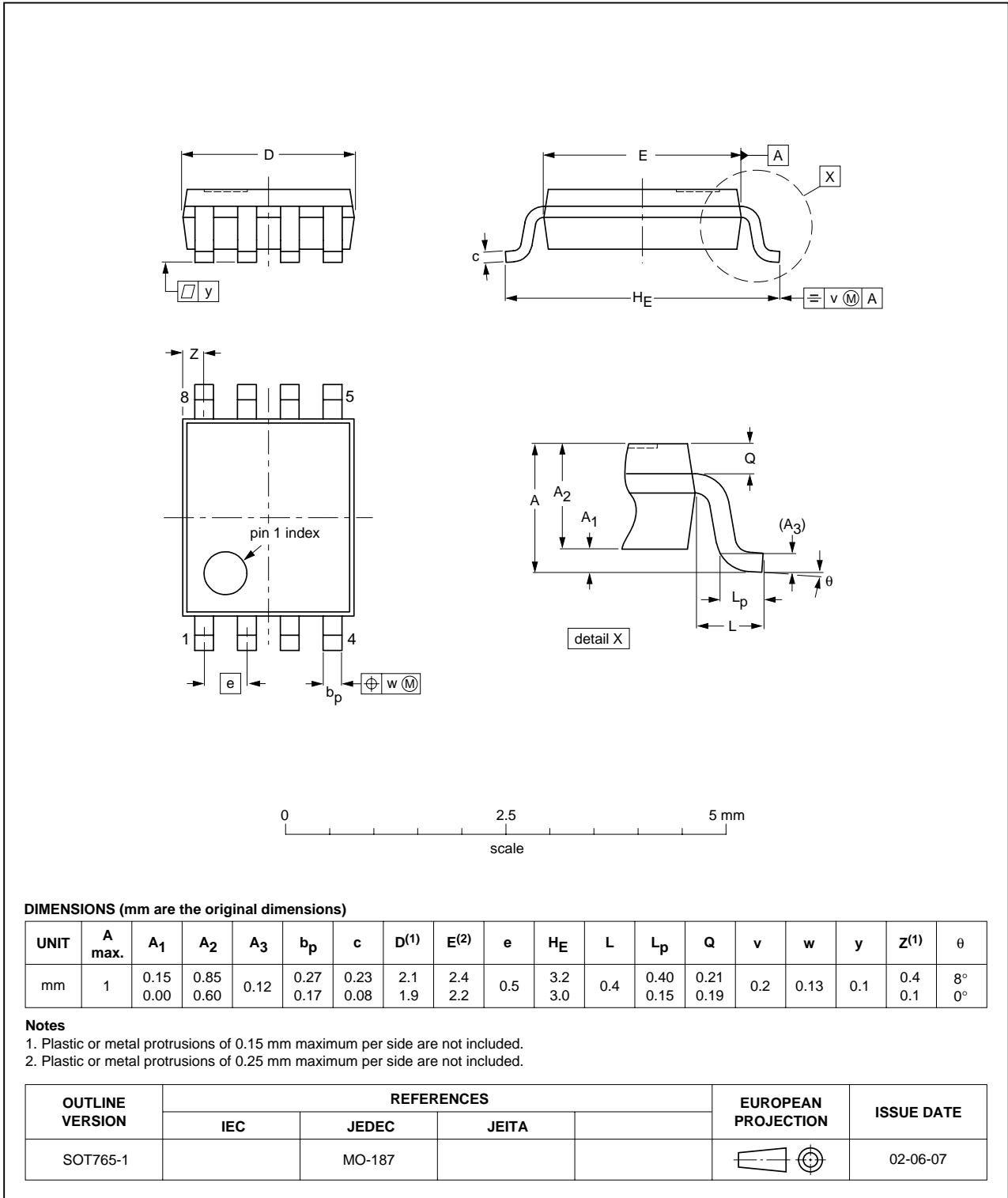


Fig 15. Package outline VSSOP8.

16. Revision history

Table 12: Revision history

| Document ID | Release date | Data sheet status | Change notice | Order number | Supersedes |
|--------------|--------------|-------------------|---------------|----------------|------------|
| 74AHC3GU04_1 | 20040305 | product data | - | 9397 750 12754 | - |

17. Data sheet status

| Level | Data sheet status ^[1] | Product status ^[2] ^[3] | Definition |
|-------|----------------------------------|--|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| II | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product. |
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[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

18. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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